

### **Description**

The VST20N100 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

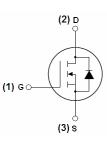
#### **General Features**

- $V_{DS} = 200V, I_{D} = 100A$  $R_{DS(ON)} < 11m\Omega @ V_{GS} = 10V$
- Excellent gate charge x R<sub>DS(on)</sub> product
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

#### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification





Schematic Diagram

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST20N100-TC	VST20N100	TO-220C	-	-	-

## Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	200	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	100	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	70.7	Α
Pulsed Drain Current	I <sub>DM</sub>	400	Α
Maximum Power Dissipation	P <sub>D</sub>	300	W
Derating factor		2	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	1216	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$ C





### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	0.5	°C/W
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	200	230	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =200V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5		4.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =50A	-	10	11	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =50A	70	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ -400\/\/ -0\/	-	4200	-	PF
Output Capacitance	Coss	$V_{DS}$ =100V, $V_{GS}$ =0V, F=1.0MHz	-	333.1	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0lvinz	-	8.8	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =100V,I <sub>D</sub> =50A V <sub>GS</sub> =10V,R <sub>G</sub> =4.7Ω	-	18	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	26	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	41	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	11	-	nS
Total Gate Charge	Qg	\/ -400\/  -504	-	63.2		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =100V, $I_{D}$ =50A, $V_{GS}$ =10V	-	24		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> -10V	-	16.4		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =100A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	100	А
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C, I_F = 50$	-	140		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	_	600		nC

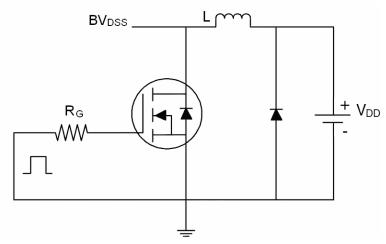
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t  $\leq$  10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V\_DD=50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

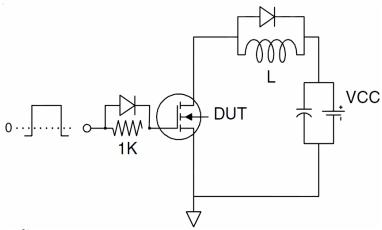


### **Test Circuit**

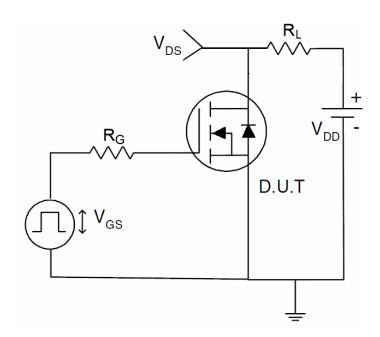
# 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit

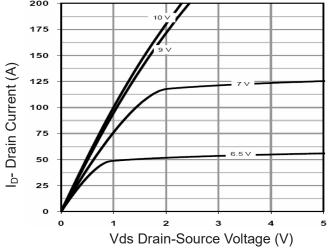


# 3) Switch Time Test Circuit

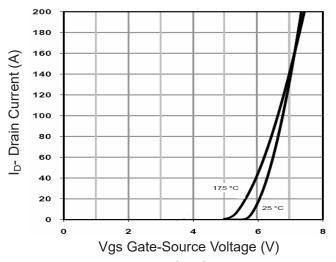








**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

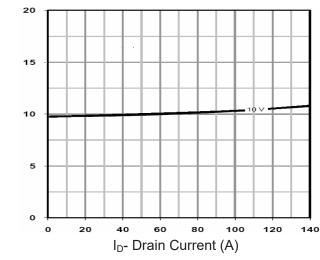


Figure 3 Rdson- Drain Current

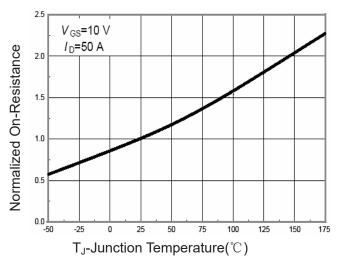


Figure 4 Rdson-JunctionTemperature

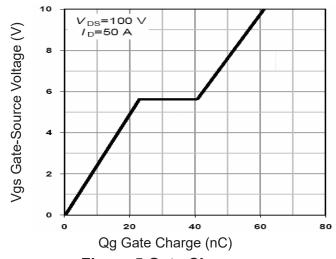


Figure 5 Gate Charge

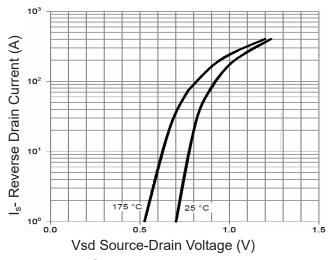
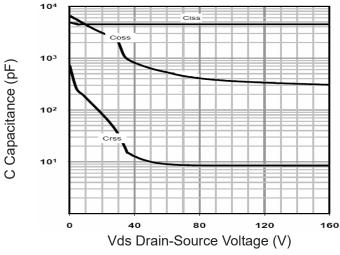


Figure 6 Source- Drain Diode Forward





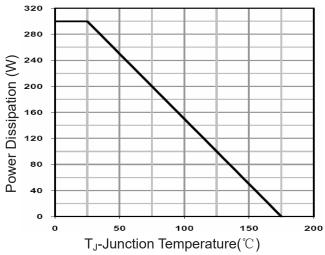
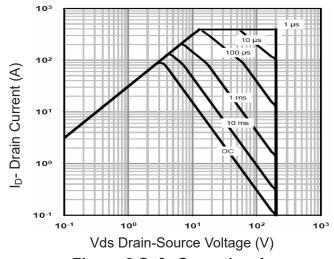


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



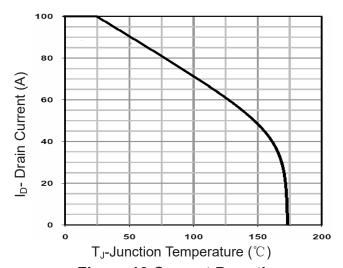
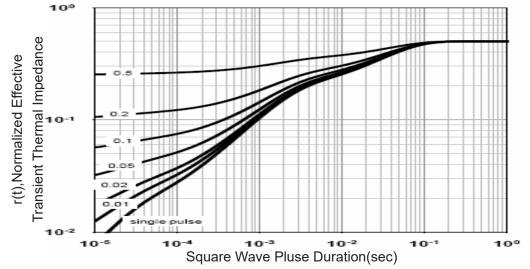


Figure 8 Safe Operation Area

Figure 10 Current De-rating



**Figure 11 Normalized Maximum Transient Thermal Impedance**